

# N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY							
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)				
100	0.124 at V <sub>GS</sub> = 10 V	4.2	4.6 nC				
100	0.128 at V <sub>GS</sub> = 4.5 V	3.9	4.6110				

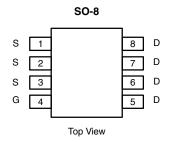
#### **FEATURES**

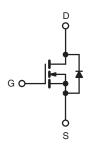
- TrenchFET® Power MOSFET
- 100 % UIS Tested

## ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- High Frequency Boost Converter
- · LED Backlight for LCD TV





N-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	100	V	
Gate-Source Voltage	$V_{GS}$	± 20	v	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	I <sub>D</sub>	4.2 3.5 3.0 <sup>a, b</sup> 2.4 <sup>a, b</sup>	A
Pulsed Drain Current		I <sub>DM</sub>	16	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	I <sub>S</sub>	4.0 2 <sup>a, b</sup>	
Single Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	6	A
Single Avalanche Energy	L=0.1 IIII	E <sub>AS</sub>	1.8	mJ
Maximum Power Dissipation	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	P <sub>D</sub>	4.8 3 2.4 <sup>a, b</sup> 1.5 <sup>a, b</sup>	w
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	$R_{thJA}$	42	53	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	21	26			

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 85  $^{\circ}\text{C/W}.$
- d. Based on  $T_C$  = 25 °C.

服务热线:400-655-8788

1



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static			I.			•
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I - 250 uA		110		\//°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 7.5		mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1		3	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zana Oata Wallana Busin Oursel	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	8			Α
		$V_{GS} = 10 \text{ V}, I_D = 2.7 \text{ A}$	0.124 0.128			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 2.5 \text{ A}$				Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2.7 A		7		S
Dynamic <sup>b</sup>		- <del>-</del>	<u> </u>			1
Input Capacitance	C <sub>iss</sub>			470		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		50		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			25		
Total Gate Charge		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2.7 \text{ A}$		7.1	11	nC
	Q <sub>g</sub>			4.6	7	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 50 \text{ V}, V_{GS} = 6 \text{ V}, I_D = 2.7 \text{ A}$		1.7		
Gate-Drain Charge	Q <sub>gd</sub>			2		
Gate Resistance	$R_{g}$	f = 1 MHz		3		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 23.8 $\Omega$		10	15	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 2.1 A, $V_{GEN}$ = 6 V, $R_g$ = 1 $\Omega$		10	15	
Fall Time	t <sub>f</sub>			10	15	
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 23.8 $\Omega$		10	15	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 2.1 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		12	20	
Fall Time	t <sub>f</sub>			10	15	1
<b>Drain-Source Body Diode Characteristi</b>	cs					
Continuous Source-Drain Diode Current	I <sub>S</sub>	$T_C = 25  ^{\circ}C$			4	А
Pulse Diode Forward Current	I <sub>SM</sub>				8	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 2.1 A, V <sub>GS</sub> = 0 V		0.8	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	80	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 2.1 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		75	120	nC
Reverse Recovery Fall Time	t <sub>a</sub>	1 <sub>F</sub> = 2.1 Λ, αι/αι = 100 Α/μs, 1 <sub>J</sub> = 25 °C		28		20
Reverse Recovery Rise Time	t <sub>b</sub>			22		ns

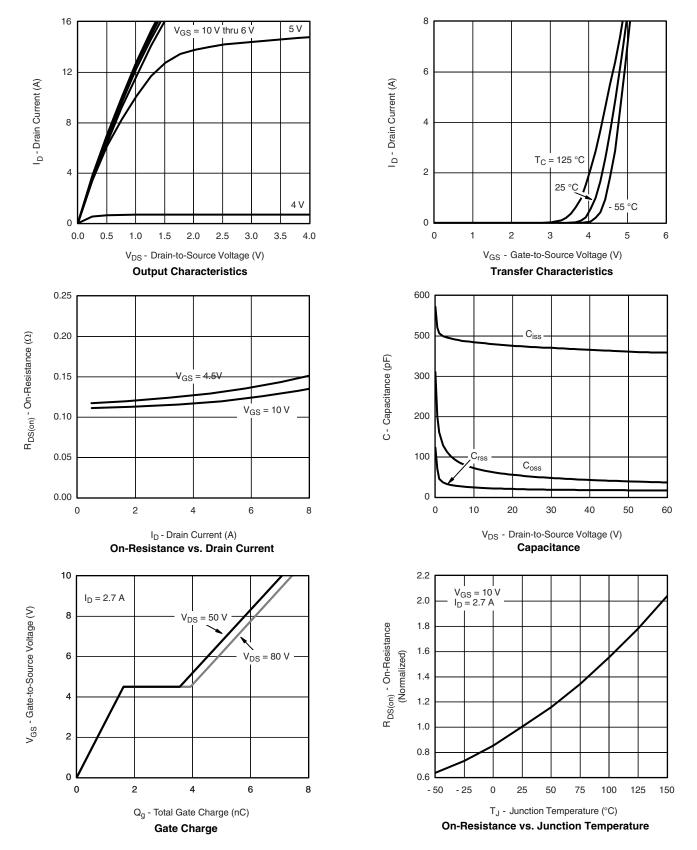
#### Notes:

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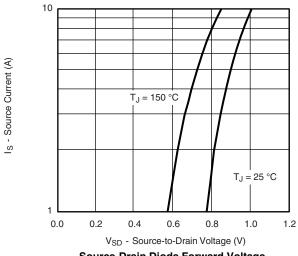
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

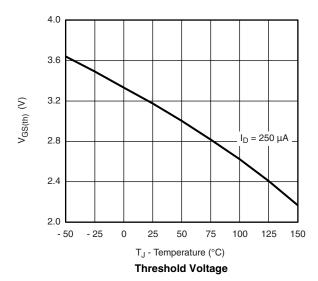


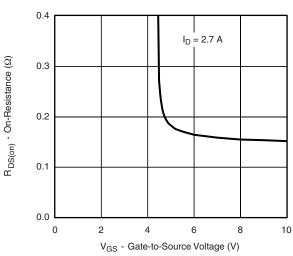




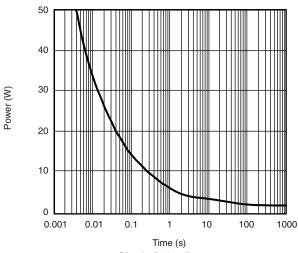


#### Source-Drain Diode Forward Voltage

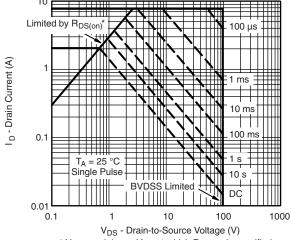




On-Resistance vs. Gate-to-Source Voltage



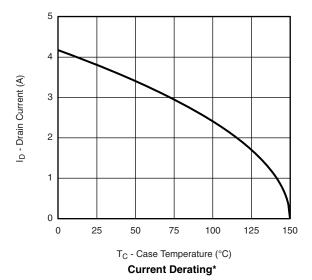
Single Pulse Power

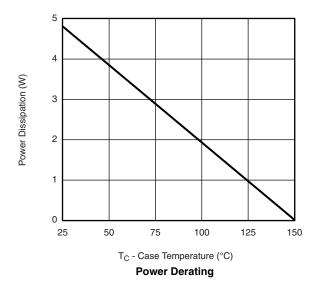


\*  $V_{GS} > \mbox{minimum} \ V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

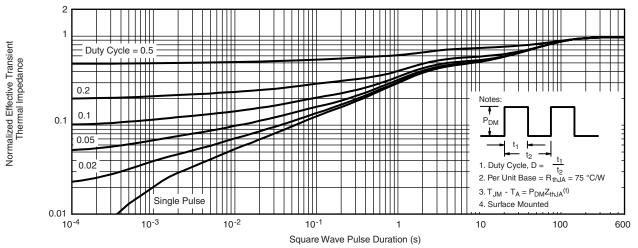




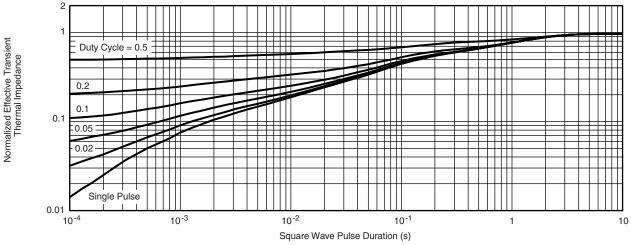


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





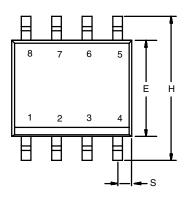
Normalized Thermal Transient Impedance, Junction-to-Ambient

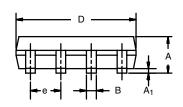


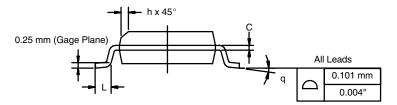
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







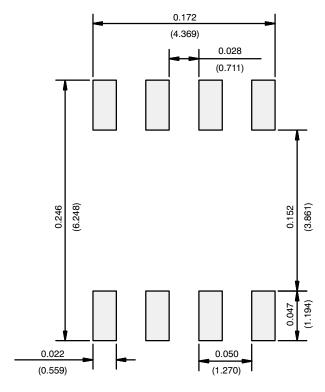
	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C 06507 Pay L 11 Cap 06					

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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